

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hiroshi NARUSE</td> <td>06/07/2012</td> </tr> <tr> <td>Yoshimitsu TANABE</td> <td>06/07/2012</td> </tr> <tr> <td>Osamu KOHGO</td> <td>06/07/2012</td> </tr> <tr> <td>Masataka MIYASATO</td> <td>06/07/2012</td> </tr> </tbody> </table>		Name	Execution Date	Hiroshi NARUSE	06/07/2012	Yoshimitsu TANABE	06/07/2012	Osamu KOHGO	06/07/2012	Masataka MIYASATO	06/07/2012
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<table border="1"> <tr> <td>Name:</td> <td>Mitsui Chemicals, Inc.</td> </tr> <tr> <td>Street Address:</td> <td>5-2, Higashi-Shimbashi 1-chome</td> </tr> <tr> <td>City:</td> <td>Minato-ku, Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>105-7117</td> </tr> </table>		Name:	Mitsui Chemicals, Inc.	Street Address:	5-2, Higashi-Shimbashi 1-chome	City:	Minato-ku, Tokyo	State/Country:	JAPAN	Postal Code:	105-7117
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CORRESPONDENCE DATA											
Fax Number:	7038367419										
Phone:	7038366620										
Email:	danielle.carro@bipc.com, adipdoc1@bipc.com										
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>											
Correspondent Name:	BUCHANAN INGERSOLL & ROONEY										
Address Line 1:	P.O. BOX 1404										
Address Line 4:	ALEXANDRIA, VIRGINIA 22313-1404										
ATTORNEY DOCKET NUMBER:	100023-000221										
NAME OF SUBMITTER:	Robert G. Mukai										
Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif											

OP \$40.00 13471765

Assignment of Application

INSERT NAMES
AND RESIDENCE
ADDRESS OF
THE INVENTORS:

WHEREAS, I (WE) 1) Hiroshi NARUSE, 2) Yoshimitsu TANABE, 3) Osamu KOHGO
and 4) Masataka MIYASATO of c/o MITSUI CHEMICALS, INC., 580-32, Nagaura,
Sodegaura-shi, Chiba 2990265 Japan, respectively,

INSERT TITLE OF
INVENTION:

have invented certain new and useful improvements in: "NOVEL COMPOUND, COMPOSITION
COMPRISING THE COMPOUND, AND CURED PRODUCT"

(Application No. _____, filed _____), and

INSERT NAMES
AND ADDRESS OF
COMPANY OR
OTHER ASSIGNEE:

WHEREAS, MITSUI CHEMICALS, INC.

(hereinafter referred to as "ASSIGNEE") having a place of business at : 5-2,
Higashi-Shimbashi 1-chome, Minato-ku, Tokyo 1057117 Japan is desirous of
acquiring the entire right, title and interest in and to said invention and in and to any Letters
Patent that may be granted therefore in the United States and its territorial possessions and in any
and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is
hereby acknowledged, and for other good and valuable consideration, I(WE), by these presents do
sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in
the United States and its territorial possessions and in all foreign countries and the entire right,
title and interest in and to any and all Letters Patent which may be granted therefor in the United
States and its territorial possessions and in any and all foreign countries and in and to any and all
divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its
territorial possessions and any and all foreign countries to issue any and all of said Letters Patent,
when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and
to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the
full end of the term for which said Letters Patent may be granted, as fully and entirely as the same
would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of BUCHANAN INGERSOLL & ROONEY PC of Suite 500 1737 King Street Alexandria, Virginia 22314-2727

U.S.A the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: June 7, 2012

Hiroshi Naruse

(Signature of Inventor) Hiroshi NARUSE

Date: June 7, 2012

Yoshimitsu Tanabe

(Signature of Inventor) Yoshimitsu TANABE

Date: June 7, 2012

Osamu Kohgo

(Signature of Inventor) Osamu KOHGO

Date: June 7, 2012

Masataka Miyasato

(Signature of Inventor) Masataka MIYASATO

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)